

PATENT ASSIGNMENT COVER SHEET

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Property Type	Number
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Total Attachments: 2	
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譲受者名:
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DENSO CORPORATION

**1-1, Showa-cho, Kariya-city, Aichi-pref., 448-8661
Japan**

as Assignee(s), and corresponding successors, assigns or other legal representatives, the entire right, title and interest, in the United States of America, and its territories, dependencies and possessions, to certain inventions known as

発明の名称:
Title of
Invention:

METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICE

上記発明についての米国登録特許証の出願は、
described in an application for Letters Patent of the United States executed

- ☒ 本譲渡証と同日、もしくは
on even date herewith
- ☐ 米国出願番号 _____ として _____ に提出されたものです。
as U.S. Application Serial No. filed on _____

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発明者はここに付随する添付書面上にリストされます。

inventor(s) listed on the attached sheet which is incorporated herein by reference.

注記: 上記日本語抄訳は、本書面の理解の助けとして付記しております。正式な解釈は英文に基づき行われます。

Note: The above Japanese text is for the purpose of helping the understanding of the reader. The interpretation of the Assignment should be based on the English text.

譲渡証(続き)
ASSIGNMENT (Cont.)

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